

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



# Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China











### **General Description**

The MAX3783 is a dual serial multiplexer (mux) and buffer with selectable line-side loopback for system interconnect and serial backplane applications up to 2.7Gbps. Each independent channel consists of a transmitter with fanout of two and a receiver with a 2:1 input mux. Selectable loopback paths support system testing.

Operating from a single 3.3V supply, this device has current-mode logic (CML) inputs and outputs, which can be AC-coupled for PECL compatibility, if desired. The IC is packaged in a compact 48-pin TQFP-EP package with exposed pad. Typical power consumption is 1.12W.

### **Applications**

2.7Gbps Serial Communications System Interconnect Serial Backplane Fail-Over and Protection Switching

Typical Application Circuit appears at end of data sheet.

#### **Features**

- ♦ Provides Redundant Serial I/O
- ♦ 11ps Deterministic Jitter
- ♦ Selectable Loopback
- ♦ On-Chip 50Ω Termination Resistors
- ♦ 3.3V Power Supply
- **♦ Two-Port Integration**

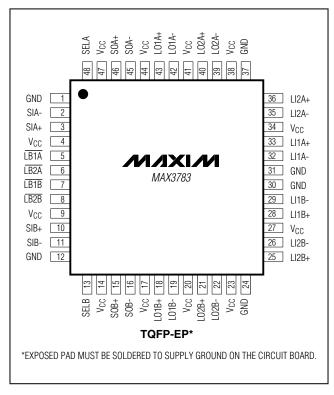
### **Ordering Information**

PART	TEMP RANGE	PIN-PACKAGE	
MAX3783UCM	0°C to +85°C	48 TQFP-EP*	
MAX3783UCM+	0°C to +85°C	48 TQFP-EP*	

\*EP = Exposed pad.

+ Denotes a lead-free package.

### Pin Configuration



### **ABSOLUTE MAXIMUM RATINGS**

Supply Voltage, VCC	0.5V to 4.0V
Continuous Current at Serial Outputs	±36mA
Voltage at SEL_, LB_ Pins0.5	$5V \text{ to } (V_{CC} + 0.5V)$
Common-Mode Input Voltage (SI_, LI_)0.5	$5V \text{ to } (V_{CC} + 0.5V)$
Differential Input Voltage (SI_, LI_) (Note 1)	±2.8V

5°C)1.76W
-55°C to +150°C
+300°C

Note 1: The sum of the common-mode voltage and differential voltage on any input pin must be within -0.5V to (VCC + 0.5V).

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### **ELECTRICAL CHARACTERISTICS**

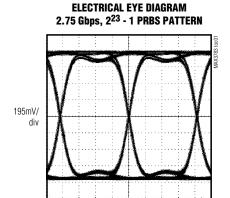
 $(V_{CC} = 3.0V \text{ to } 3.6V, \text{ serial data rate} = 2.75 \text{Gbps}, T_A = 0^{\circ}\text{C} \text{ to } +85^{\circ}\text{C}. \text{ Typical values at } V_{CC} = 3.3V, T_A = +25^{\circ}\text{C}, \text{ unless otherwise noted.})$ 

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Maximum Serial Data Rate			2.75	3.125		Gbps
Power Dissipation		AC-coupled inputs, outputs		1.12	1.68	W
Supply Current	Icc			340	466	mA
CML Differential Output Voltage	V <sub>OD</sub>	$R_L = 50\Omega$ to $V_{CC}$ , or $100\Omega$ differential (Note 2)	1200	1500	2200	mVp-p
CML Differential Input Voltage	V <sub>ID</sub>		200	1600	2200	mVp-p
CML Output Impedance	Rout	Single ended	42.5	50	57.5	Ω
CML Input Impedance	R <sub>IN</sub>	Differential	85	100	116	Ω
Random Jitter		(Note 3)		1	2	psrms
Deterministic Jitter		(Notes 3, 4, 5)		11	25	ps <sub>p-p</sub>
CML Output Edge Speed	to to	2.5Gbps input (Note 6)		70	135	no
(20% to 80%)	t <sub>R</sub> , t <sub>F</sub>	1.25Gbps input (Note 3)		80	200	ps
Propagation Delay		LI_ to SO_, SI_ to LO_, LI_ to LO_ (Note 3)		340	500	ps
Multiplexer Switch Time		SEL_ or $\overline{LB}$ to valid output		9		ns
TTL Input Current High		$V_{IH} = +2.0V \text{ to } (V_{CC} +0.3V)$			180	μΑ
TTL Input Current Low		$V_{IL} = -0.3V \text{ to } +0.8V$			440	μΑ

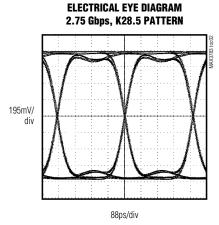
- Note 2: Tested using a repeating 1010 pattern at 500Mbps.
- **Note 3:** AC specifications are guaranteed by design and characterization.
- **Note 4:** Deterministic jitter is measured with a repeating K28.5 pattern.
- Note 5: With the peak-to-peak input swing on the selected (transmitted) CML input equal to or greater than that on the nonselected inputs.
- Note 6: AC specifications are guaranteed by test.

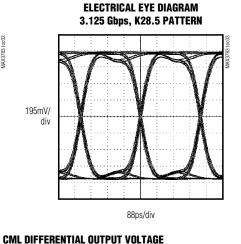
## **Typical Operating Characteristics**

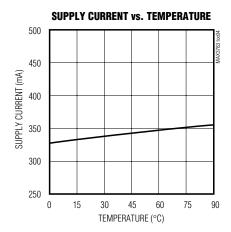
 $(V_{CC} = 3.3V, T_A = +25^{\circ}C, unless otherwise noted.)$ 

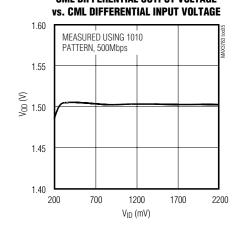


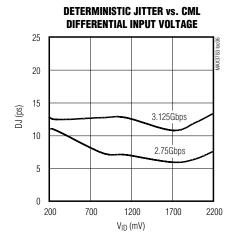
88ps/div

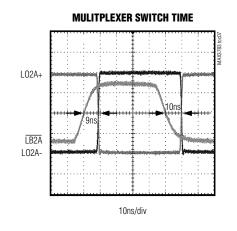










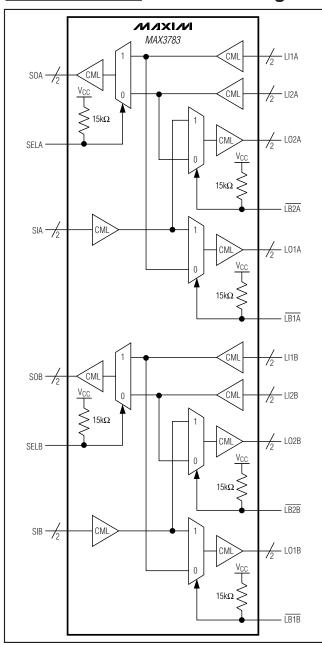


## \_Pin Description

PIN	NAME	FUNCTION
1, 12, 24, 30, 31, 37	GND	Supply Ground
2	SIA-	Serial Input A Negative, CML
3	SIA+	Serial Input A Positive, CML
4, 9, 14, 17, 20, 23, 27, 34, 38, 41, 44, 47	Vcc	+3.3V Supply
5	LB1A	Line Out 1A Loopback Mode Select. TTL low selects loopback.
6	LB2A	Line Out 2A Loopback Mode Select. TTL low selects loopback.
7	LB1B	Line Out 1B Loopback Mode Select. TTL low selects loopback.
8	LB2B	Line Out 2B Loopback Mode Select. TTL low selects loopback.
10	SIB+	Serial Input B Positive, CML
11	SIB-	Serial Input B Negative, CML
13	SELB	Serial Output B Input Select, TTL
15	SOB+	Serial Output B Positive, CML
16	SOB-	Serial Output B Negative, CML
18	LO1B+	Line Out 1B Positive, CML
19	LO1B-	Line Out 1B Negative, CML
21	LO2B+	Line Out 2B Positive, CML
22	LO2B-	Line Out 2B Negative, CML
25	LI2B+	Line In 2B Positive, CML
26	LI2B-	Line In 2B Negative, CML
28	LI1B+	Line In 1B Positive, CML
29	LI1B-	Line In 1B Negative, CML
32	LI1A-	Line In 1A Negative, CML
33	LI1A+	Line In 1A Positive, CML
35	LI2A-	Line In 2A Negative, CML
36	LI2A+	Line In 2A Positive, CML
39	LO2A-	Line Out 2A Negative, CML
40	LO2A+	Line Out 2A Positive, CML
42	LO1A-	Line Out 1A Negative, CML
43	LO1A+	Line Out 1A Positive, CML
45	SOA-	Serial Output A Negative, CML
46	SOA+	Serial Output A Positive, CML
48	SELA	Serial Out A Input Select, TTL
EP	Exposed Pad	Ground. Must be soldered to the circuit board for proper thermal and electrical performance (see the Exposed-Pad (EP) Package section).

NIXIN \_\_\_\_\_

### **Functional Diagram**



### **Detailed Description**

The MAX3783 is a 2.7Gbps dual serial mux/buffer with selectable line-side loopback for system test. Each half of the MAX3783 provides a transmitter with a fanout of two and a receiver with a 2:1 mux, as shown in the functional diagram.

#### **Input Stages**

The input amplifiers accept CML or AC-coupled PECL signals and each input has an on-chip  $100\Omega$  differential impedance for optimal termination, as shown in Figure 1.

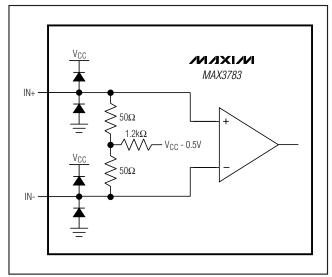


Figure 1. Input Structure

#### **Control Lines**

TTL-compatible control lines are provided to select the MAX3783's operating mode (Table 1). SELA and SELB set the mux for channels A and B, respectively, to select LI1\_ or LI2\_ to connect to the SO\_ output. LB1A, LB1B, LB2A, and LB2B enable loopback mode for each of the four LO\_ outputs. All control lines are internally pulled high through  $15k\Omega$  resistors.

**Table 1. Operating Modes** 

SEL_	SO_
0	LI2_
1	LI1_

LB_	LO_
0	LI_
1	SI_

### **Output Buffers**

The outputs are high-speed CML interfaces with  $50\Omega$  back termination, as shown in Figure 2.

#### Exposed-Pad (EP) Package

The exposed pad on the 48-pin TQFP-EP provides a very low thermal-resistance path for heat removal from the IC. The pad is also electrical ground on the MAX3783 and must be soldered to the circuit board for proper thermal and electrical performance.

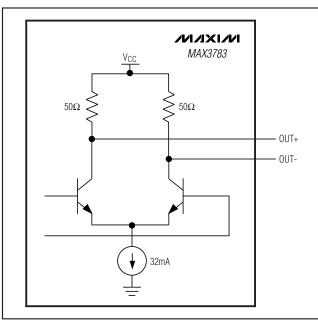


Figure 2. CML Output Structure

## Chip Information

TRANSISTOR COUNT: 2816

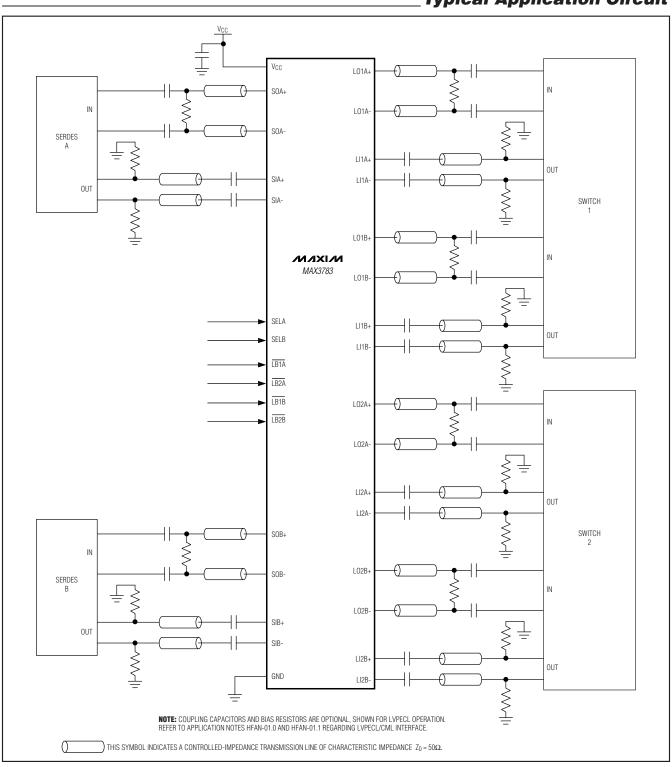
PROCESS: BiPOLAR

### Package Information

(For the latest package outline information, go to **www.maxim-ic.com/packages**.)

PACKAGE TYPE	DOCUMENT NO.
48 TQFP-EP	<u>21-0065</u>

## Typical Application Circuit



### **Revision History**

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	10/01	Initial release.	_
1	3/06	Added lead-free device to the Ordering Information table.	1
2	1/08	In the Electrical Characteristics table, modified Note 2 and added Note 6 for $t_R$ , $t_F$ ; replaced package outline drawings with table.	2, 8, 9

Maxim cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim product. No circuit patent licenses are implied. Maxim reserves the right to change the circuitry and specifications without notice at any time.